

6 Lake Street, Lawrence, MA 01841 1-800-446-1158 / (978) 620-2600 / Fax: (978) 689-0803

Website: http://www.microsemi.com

Gort Road Business Park, Ennis, Co. Clare, Ireland. Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

PNP SILICON SWITCHING TRANSISTOR

Qualified per MIL-PRF-19500/512

DEVICES

2N4029 2N4033

> 2N4033UA 2N4033UB

LEVELS JAN JANTX JANTXV

JANS

ABSOLUTE MAXIMUM RATINGS ($T_C = +25$ °C unless otherwise noted)

Parameters / Test Condi	Symbol	Value	Unit	
Collector-Emitter Voltage		V_{CEO}	80	Vdc
Collector-Base Voltage		V_{CBO}	80	Vdc
Emitter-Base Voltage		$V_{\rm EBO}$	5.0	Vdc
Collector Current		I_{C}	1.0	Adc
Total Power Dissipation @ T _A = +25°C	2N4029 ¹ 2N4033 ² 2N4033UA, UB ³	P_{T}	0.5 0.8 0.5	W
Operating & Storage Junction Tempera	T_j , T_{stg}	-65 to +200	°C	
Thermal Resistance, Junction-to-Case	2N4029 2N4033	$R_{\theta JC}$	80 40	°C/W

Note:

- 1. Derate linearly $2.86 \text{mW/}^{\circ}\text{C}$ for $T_A > +25 ^{\circ}\text{C}$
- 2. Derate linearly $4.56 \text{mW/}^{\circ}\text{C}$ for $T_A > +25 ^{\circ}\text{C}$
- 3. For UB package and use $R_{\theta JC}$ or see thermal curves in /512

ELECTRICAL CHARACTERISTICS ($T_A = +25$ °C, unless otherwise noted)

Parameters / Test Conditions	Symbol	Min.	Max.	Unit					
OFF CHARACTERTICS									
	I_{CBO}		10 10 25	μAdc ηAdc μAdc					
Emitter-Base Cutoff Current $V_{EB} = 5.0 Vdc$ $V_{EB} = 3.0 Vdc$	I_{EBO}		10 25	μAdc ηAdc					
Collector-Emitter Cutoff Current $V_{BE} = 2.0 Vdc$, $V_{CE} = 60 Vdc$	I_{CEX}		25	ηAdc					



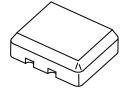
TO-18 (TO-206AA) 2N4029



TO-39 (TO-205AD) 2N4033



UA Package



UB Package



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ELECTRICAL CHARACTERISTICS ($T_A = +25$ °C, unless otherwise noted)

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
ON CHARACTERISTICS (3)				
Forward-Current Transfer Ratio				
$I_{C} = 100 \mu Adc, V_{CE} = 5.0 Vdc$		50		
$I_C = 100 \text{mAdc}, V_{CE} = 5.0 \text{Vdc}$		100	300	
$I_C = 500 \text{mAdc}, V_{CE} = 5.0 \text{Vdc}$	${ m h}_{ m FE}$	70		
$I_{C} = 1.0 Adc, V_{CE} = 5.0 Vdc$		25		
$I_C = 500 \text{mAdc}, V_{CE} = 5.0 \text{Vdc}, T_A = -55 ^{\circ}\text{C}$		30		
Collector-Emitter Saturation Voltage				
$I_C = 150 \text{mAdc}, I_B = 15 \text{mAdc}$	V		0.15	Vdc
$I_C = 500 \text{mAdc}, I_B = 50 \text{mAdc}$	$V_{CE(sat)}$		0.50	v uc
$I_C = 1.0 \text{Adc}, I_B = 100 \text{mAdc}$			1.0	
Base-Emitter Voltage			0.0	
$I_C = 150 \text{mAdc}, I_B = 15 \text{mAdc}$	$V_{\mathrm{BE}(\mathrm{sat})}$		0.9	Vdc
$I_C = 500 \text{mAdc}, I_B = 50 \text{mAdc}$			1.2	

DYNAMIC CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Magnitude of Common Emitter Small–Signal Short-Circuit Forward Current Transfer Ratio $I_C = 50 mAdc, \ V_{CE} = 10 Vdc, \ f = 100 MHz$	$ \mathrm{h_{fe}} $	1.5	6.0	
Output Capacitance $V_{CB} = 10 V dc, I_E = 0, 100 kHz \le f \le 1.0 MHz$	C_{obo}		20	pF
Input Capacitance $V_{EB} = 0.5 Vdc, I_C = 0, 100 kHz \le f \le 1.0 MHz$	C _{ibo}		80	pF

SWITCHING CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
On-Time $V_{CC} = 31.9 \text{Vdc}$; $I_C = 500 \text{mAdc}$; $I_{B1} = 50 \text{mAdc}$	^t d		15	ηs
Rise Time $V_{CC} = 31.9 \text{Vdc}$; $I_C = 500 \text{mAdc}$; $I_{B1} = 50 \text{mAdc}$	^t r		25	ηs
Storage Time $V_{CC} = 31.9V$, $I_C = 500$ madc, $I_{B1} = 50$ mAdc	^t S		175	ηs
Fall Time $V_{CC} = 31.9V$, $I_C = 500$ madc, $I_{B1} = 50$ mAdc	^t f		35	ηs

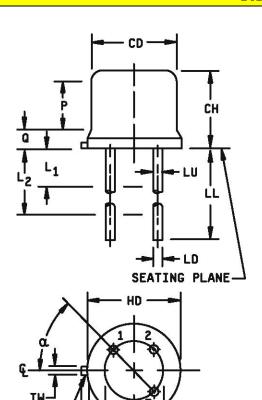
⁽⁴⁾ Pulse Test: Pulse Width = $300\mu s$, Duty Cycle $\leq 2.0\%$.



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PACKAGE DIMENSIONS



Symbol	bol Inches		Millir	Notes	
	Min	Max	Min	Max	
CD	.178	.195	4.52	4.95	
СН	.170	.210	4.32	5.34	
HD	.209	.230	5.31	5.84	
LC	.100	.100 TP		1 TP	6
LD	.016	.021	0.41	0.53	7, 8
LL	.500	.750	12.70	19.05	7, 8, 12
LU	.016	.019	0.41	0.48	7, 8
L_1		.050		1.27	7, 8
L_2	.250		6.35		7, 8
Q		.040		1.02	5
TL	.028	.048	0.71	1.22	3, 4
TW	.036	.046	0.91	1.17	3
r		.010		0.25	10
P	.100		2.54		
α		6			

NOTES:

- 1 Dimension are in inches.
- 2 Millimeters equivalents are given for general information only.
- 3 Beyond r (radius) maximum, TW shall be held for a minimum length of .011 (0.28 mm).
- 4 Dimension TL measured from maximum HD.
- 5 Body contour optional within zone defined by HD, CD, and Q.
- 6 Leads at gauge plane .054 +.001 -.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within .007 inch (0.18mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. The device may be measured by direct methods.
- 7 Dimension LU applies between L₁ and L₂. Dimension LD applies between L₂ and minimum. Diameter is uncontrolled in L₁ and beyond LL minimum.
- 8 All three leads.
- 9 The collector shall be internally connected to the case.
- 10 Dimension r (radius) applies to both inside corners of tab.
- 11 In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.
- 12 For "L" suffix devices, dimension LL is 1.50 (38.10mm) minimum, 1.75 (44.45mm) maximum.

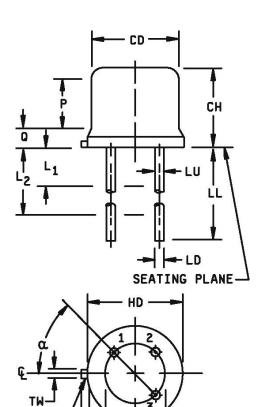
FIGURE 1. Physical dimensions for 2N4029 (TO-18).



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Symbol	Inc	hes	Millir	neters	Notes
	Min	Max	Min	Max	
CD	.305	.335	7.75	8.51	
СН	.240	.260	6.10	6.60	
HD	.335	.370	8.51	9.40	
LC	.200) TP	5.08	3 TP	6
LD	.016	.021	0.41	0.53	7, 8
LL	.500	.750	12.70	19.05	7, 8, 12
LU	.016	.019	0.41	0.48	7, 8
L_1		.050		1.27	7, 8
L_2	.250		6.35		7, 8
Q		.050		1.27	5
TL	.029	.045	0.74	1.14	3, 4
TW	.028	.034	0.71	0.86	3
r		.010		0.25	10
P	.100		2.54		
α		6			

NOTES:

- 1 Dimension are in inches.
- Millimeters equivalents are given for general information only. 2
- 3 Beyond r (radius) maximum, TW shall be held for a minimum length of .011 (0.28 mm).
- Dimension TL measured from maximum HD. 4
- Body contour optional within zone defined by HD, CD, and Q. 5
- Leads at gauge plane .054 +.001 -.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within .007 inch (0.18mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. The device may be measured by direct methods.
- 7 Dimension LU applies between L_1 and L_2 . Dimension LD applies between L_2 and minimum. Diameter is uncontrolled in L_1 and beyond LL minimum.
- All three leads. 8
- 9 The collector shall be internally connected to the case.
- 10 Dimension r (radius) applies to both inside corners of tab.
- 11 In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.
- 12 For "L" suffix devices, dimension LL is 1.50 (38.10mm) minimum, 1.75 (44.45mm) maximum.

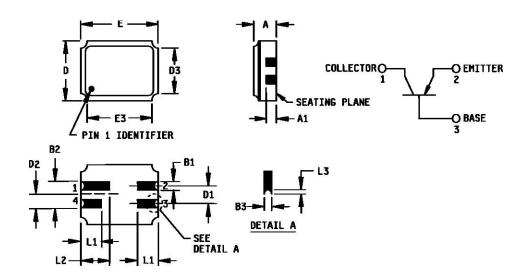
FIGURE 2. Physical dimensions for 2N4033 (TO-39).



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		Dime	nsions			Dimensions					
Ltr.	Inc	hes	Millin	neters	Note	Ltr.	Inc	hes	Millir	neters	Note
	Min	Max	Min	Max			Min	Max	Min	Max	
Α	.061	.075	1.55	1.91	3	D_2	.0375	BSC	0.952	BSC	
A_1	.029	.041	0.74	1.04		D_3		.155		3.94	
\mathbf{B}_1	.022	.028	0.56	0.71		Е	.215	.225	5.46	5.72	
B_2	.075	REF	1.91	REF		E_3		.225		5.72	
B_3	.006	.022	0.15	0.56	5	L_1	.032	.048	0.81	1.22	
D	.145	.155	3.68	3.93		L_2	.072	.088	1.83	2.24	
D_1	.045	.055	1.14	1.39		L_3	.003	.007	0.08	0.18	5

NOTES:

- 1 Dimensions are in inches.
- 2 Millimeters equivalents are given for general information only.
- 3 Dimension "A" controls the overall package thickness. When a window lid is used, dimension "A" must increase by a minimum of .010 inch (0.254 mm) and a maximum of .040 inch (1.020 mm).
- 4 The corner shape (square, notch, radius, etc) may vary at the manufacturer's option, from that shown on the drawing.
- 5 Dimensions "B3" minimum and "L3" minimum and the appropriately castellation length define an unobstructed threedimensional space traversing all of the ceramic layers in which a castellation was designed. (Castellations are required on bottom two layers, optional on top ceramic layer.) Dimension "B3" maximum and "L3" maximum define the maximum width and depth of the castellation at any point on its surface. Measurement of these dimensions may be made prior to solder dipping.
- 6 In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

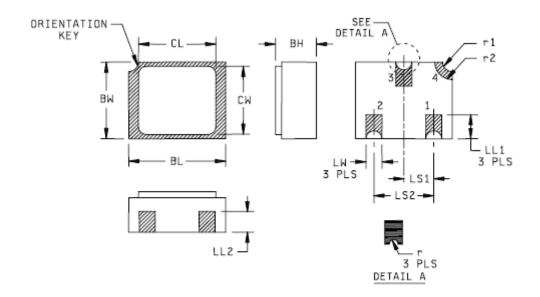
FIGURE 3. Physical dimensions, surface mount (UA version).

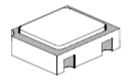


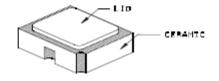
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	Dimensions					
Symbol	Inches		Millimeters		Note	
	Min	Max	Min	Max		
BH	.046	.056	1.17	1.42		
BL	.115	.128	2.92	3.25		
BW	.085	.108	2.16	2.74		
CL		.128		3.25		
CW		.108		2.74		
LL1	.022	.038	0.56	0.96		
LL2	.017	.035	0.43	0.89		

Symbol	Inches		Millin	neters	Note
	Min	Max	Min	Max	
LS1	.036	.040	0.91	1.02	
LS2	.071	.079	1.81	2.01	
LW	.016	.024	0.41	0.61	
r		.008		.203	
r1		.012		.305	
r2		.022		.559	

NOTES:

- 1 Dimensions are in inches.
- 2 Millimeters are given for general information only.
- 3 Hatched areas on package denote metalized areas.
- 4 Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Shielding connected to the lid.
- 5 In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

FIGURE 4. Physical dimensions, surface mount (UB version).